



W-GM-4200

Wafer Edge Grinding Machine

- Best Seller Machine W-GM-Series
- Improve the Space Efficiency by the Compact Design
- Highly Accurate Grinding by the Synchronized X · Y · θ Support Control
- Easy Operation by Touch Panel
- Automatic feed-back of processing result will be given



TOSEI ENGINEERING CORP.

Specification of W-GM-4200

Basic Specification		
Wafer Size		ϕ 2" \sim ϕ 6" / ϕ 5" \sim ϕ 8"
Wafer Thickness		0.4 \sim 1.0mm (Standard)
Wafer Type		OF, CF \times 2 (<1/2 OF), Notch (Option)
Grinding Unit		2-stage
Periphery Grinding Wheel	OD (Groove)	ϕ 200mm
	OD (Periphery)	ϕ 202mm
	ID	ϕ 30mm
	Flange Thickness	20mm
Peripheral Speed of Periphery Grinding Wheel (ϕ 202)		2500m/min (Maximum)
Grinding Speed		Periphery, OF and notch can be set individually
Periphery Grinding Spindle		ϕ 5 \sim ϕ 8 : Built-in motor ϕ 2 \sim ϕ 6 : Belt drive by magnet motor
Operation Panel		12" color LCD panel with touch sensor
Signal Tower		3-color Indicator
Dimensions		2115 (W) x 1410 (D) x 2000 (H) mm
Weight		Approx. 3000kg
Mechanical Specification		
Grinding Table X, Y, Z-axis	Resolution	1 μ m
Grinding Table θ -axis	Resolution	0.001°
	Driving System	Harmonic Drive & AC Servo Motor
Transfer Unit	Loading System	Chuck Loading (Upper Surface)
Cleaning Unit	Cleaning System	Spin Cleaning
	Drying System	Dry Air
Loader Unit	Type	Cassette Carrier Type
	Number of Cassette	4C
Measuring Unit Specification		
Wafer Thickness Measurement	Resolution	1 μ m
	Repeatability Accuracy	Within \pm 2 μ m
	Measuring Type	Contact Type or Non Contact Type
	Measuring Equipment	Contact Type: Accretech MINIAX (Moiré Scale) Non Contact Type: Accretech CADICOM
Non-contact Alignment System	Type	Laser System
	Resolution	1 μ m
	Centering Accuracy	Within \pm 50 μ m

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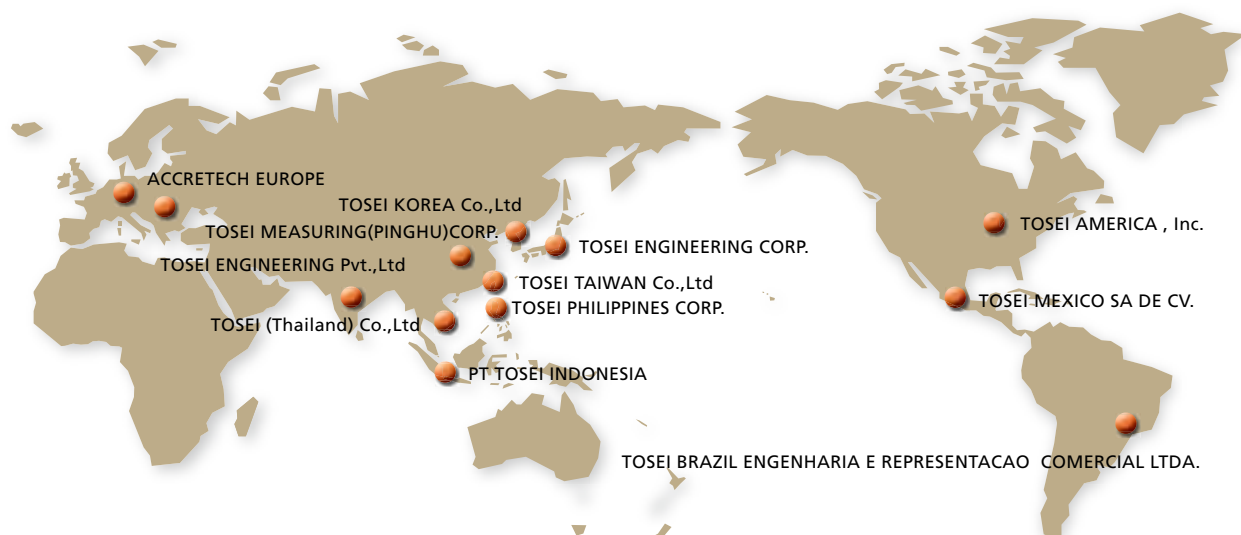
(Head Office)

4-6, Higashi-Nakanuki-cho, Tsuchiura-city Ibaraki 300-0006, Japan
TEL: 81-29-830-1888 FAX: 81-29-830-1881

(Machinery Division)

2-14 Kita-kandatsu-machi, Tsuchiura-city Ibaraki 300-0015, Japan
TEL: 81-29-830-1882 (Contact phone) FAX: 81-29-832-5742

Worldwide NETWORK



URL <http://www.toseieng.co.jp/>